

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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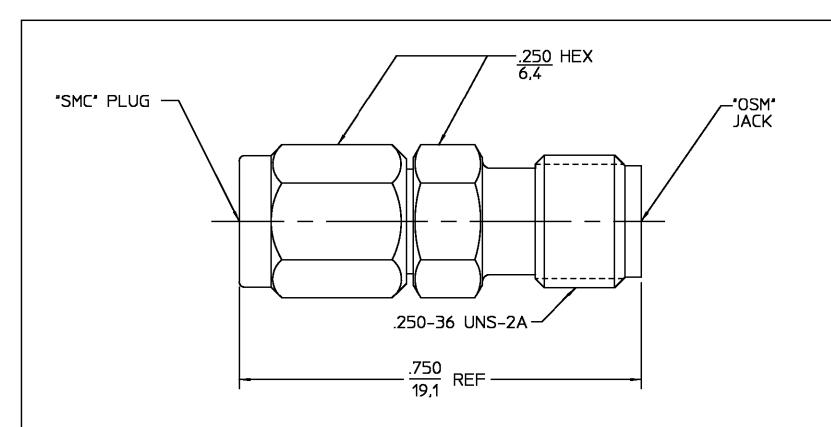
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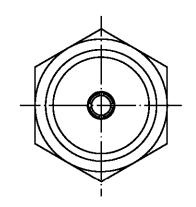








i	REVISIONS		
REV	DESCRIPTION	DATE	APPROVED
01 ₀	RELEASED	4/14/99	02DP



NOTES:

1. CAPTURED CENTER CONTACT

ELECTRICAL	MECHANICAL			ENVIRONMENTAL		
Nominal Impedance (Ohms) 50	Interface Dimensions			Temperature Rating -65°C to +125°C		
Frequency Range (GHz) DC to 4.0	SMB MIL-STD-348A 311-1			Vibration MIL-STD-202, Method		
Volt Rating (VRMS MAX)	OSM MIL-STD-348A 310-2			204, Condition B		
© Sea Level 335	Recommended Mating Torque			Shock MIL-STD-202, Method 213,		
VSWR 1.25+.04f(GHz)	SMC 30-50 In-0zs			Condition B		
Insertion Loss (dB MAX)03 8 1.5GHz	Mating Characteristics:			Thermal Shock MIL-STD-202,		
RF Leakage (dB MIN) -55 9 2 to 3 GHz	<u> </u>	SMB	OSM	Method 107, Condition B,		
Corona, 70,000 Ft (VRMS MIN) 250	Insertion	2.5	3.0	Except High Temp +85°C		
Dielectric Withstanding Voltage	Withdrawal	1.0	2.0	Moisture Resistance MIL-STD-202,		
(VRMS MIN) 8 Sea Level 1,000	Force to Engage/Disengage (Lbs)			Method 106 Shall Be Omitted		
Contact Resistance (Milliohms MAX)		SMB	14.0	Corrosion - MIL-STD-202, Method		
Center Contact 6.0		OSM	2.0	101, Condition B, 5% salt spray		
Outer Contact 1.0	Contact Retention					
RF High Potential 6 Sea Level	Axial (Lbs)		6.0			
(VRMS MIN 8 5 MHz) 700	Radial (In-O <u>z) 4.0</u>		4.0	.XXX = in		
I.R.(Megohms MIN) 1,000	Weight (Grams) TBD		TBD	$\overline{XX.X} = mm (REF)$		

HOUSING COUPLING NUT	STAINLESS STEE ASTM-A484 AND A582. TYPE 303	ASTM-	PASSIVATE PER QQ-P-35			
DIELECTRIC		PTFE FLUOROCARBON PER ASTM-D-1457		N/A		
CENTER CONTACT	BERYLLIUM COPP ASTM-B-196 OR ALLOY C17300,	ASTM-B-197,	GOLD PLATE PER MIL-G-45204			
RETAINING RING	ASTM-B-194, AL	BERYLLIUM COPPER PER ASTM-B-194, ALLOY C17200, CONDITION H		N/A		
COMPONENT	MATERI	MATERIAL		FINISH		
DIMENSIONS ARE IN INCHES	AWN BY DATE IDY 1/21/98 ECKED BY		ncorporated			
FRAC. DEC. ANGLES # 1/32 #.005 # 2° APF	PPD BY ODD 4/14/99	140 Fourth Avenue Waltham, MA 02451-7599				
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permission.		SCALE 6:1		SHEET 1 OF 1		

CUSTOMER DRAWING

AMP PART # 1060272-1 SHEET 1 OF 1 REV A